HMC271LP4 / 271LP4E

v02.0705

1 dB LSB GaAs MMIC 5-BIT SERIAL CONTROL DIGITAL ATTENUATOR, 0.7 - 3.7 GHz

EARTH FRIENDLY

RoHS✓ COMPLIANT

Typical Applications

The HMC271LP4 / HMC271LP4E is ideal for:

- Cellular/3G Infrastructure
- Fixed Wireless & WiMax
- Test Instrumentation

Features

1 dB LSB Steps to 31 dB

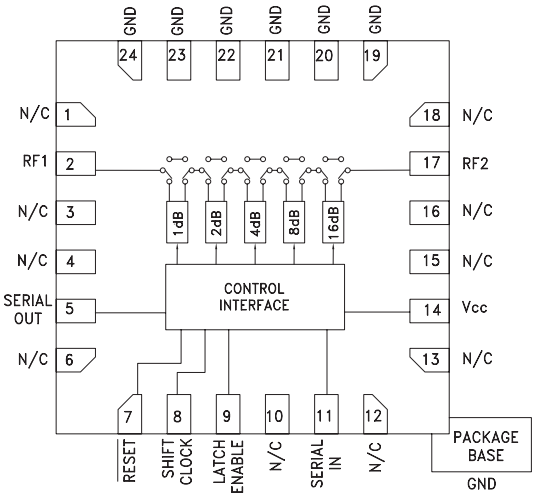
CMOS Compatible Serial Data Interface

SPI Compatible Serial Output

+/- 0.4 dB Typical Bit Error

4 x 4 mm QFN Plastic Package

Functional Diagram



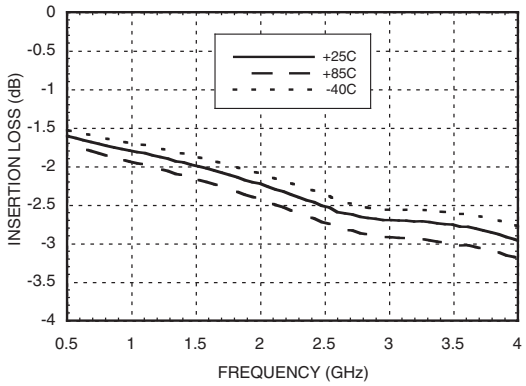
General Description

The HMC271LP4 & HMC271LP4E are broadband 5-bit positive control GaAs IC digital attenuators with serial-to-parallel drivers in low cost leadless QFN 4x4 mm SMT packages. Covering 0.7 to 3.7 GHz, the insertion loss is typically less than 2.5 dB. The attenuator bit values are 1 (LSB), 2, 4, 8, and 16 dB for a total attenuation of 31 dB. Accuracy is excellent at ± 0.4 dB typical with an IIP3 of up to +48 dBm. Five bit CMOS compatible serial control words are used to select each attenuation state. A single Vcc bias of +3V to +5V applied through an external 5k Ohm resistor is required.

Electrical Specifications, T_A = +25° C, Vcc = +3V to +5V

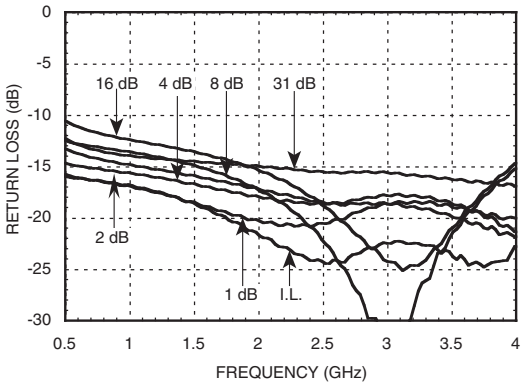
Parameter		Frequency	Min.	Typical	Max.	Units
Insertion Loss		0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz 2.7 - 3.7 GHz		1.9 2.3 2.6 2.8	2.4 2.8 3.1 3.3	dB dB dB dB
Attenuation Range		0.7 - 3.7 GHz		31		dB
Return Loss (RF1 & RF2, All Atten. States)		0.7 - 1.4 GHz 1.4 - 2.7 GHz 2.7 - 3.7 GHz		12 15 16		dB dB dB
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States		0.7 - 3.7 GHz	± 0.4 ± 5% of Atten. Setting Max			dB
Input Power for 0.1 dB Compression	Vcc = 5V Vcc = 3V	0.7 - 3.7 GHz		24 22		dBm dBm
Input Third Order Intercept Point (Two-tone Input Power = 0 dBm Each Tone)	Vcc = 5V Vcc = 3V	0.7 - 3.7 GHz		48 46		dBm dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (Latch Enable to 10/90% RF)		0.7 - 3.7 GHz		750 830		ns ns

Insertion Loss



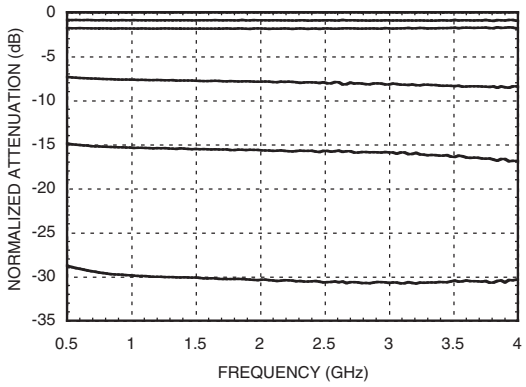
Return Loss RF1, RF2

(Only Major States are Shown)

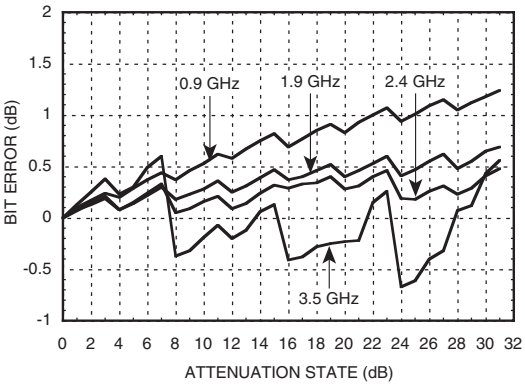


Normalized Attenuation

(Only Major States are Shown)

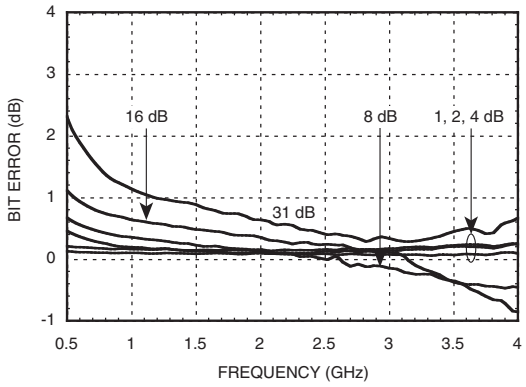


Bit Error vs. Attenuation State



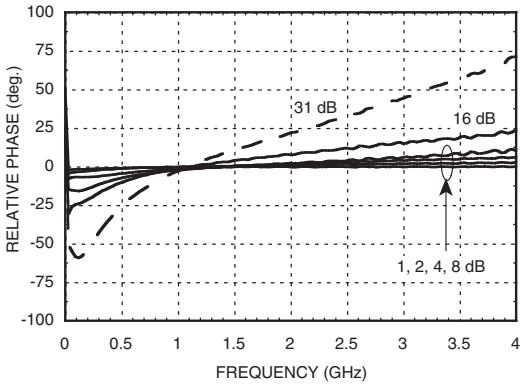
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)



Note: All Data Typical Over Voltage (+3V to +5V) & Temperature (-40 to +85 deg. C.).

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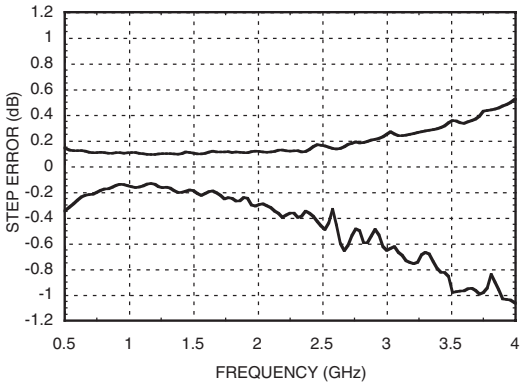
Worst Case Step Error Between Successive Attenuation States



CMOS Control Voltages

State	Vcc = +5V	Vcc = +3V
Low	0 to 1.3V	0 to 0.7V
High	3.5 to 5.0V	2.3 to 3.0V

Serial Input Truth Table

Latch Enable	Shift Lock	$\overline{\text{Reset}}$	Function
X	X	L	Shift register cleared
X	↑	H	Shift register locked
↑	X	H	Contents of shift register transferrred to output latches

Timing

Parameter	Symbol	Vcc = +5V		Vcc = +3V		Unit
		Min.	Max.	Min.	Max.	
Serial IN Setup Time	ts	20	-	100	-	ns
Hold time from Serial In to Shift Clock	th	0	-	5	-	ns
Setup time from Shift clock to Latch Enable	tlsup	40	-	100	-	ns
Propogation delay, Latch enable to Qa through Qh	tpd	-	30	-	70	ns
Setup time from Reset to Shift Clock	-	20	-	50	-	ns
Clock Frequency (1/tclk)	fclk	-	30	-	10	MHz

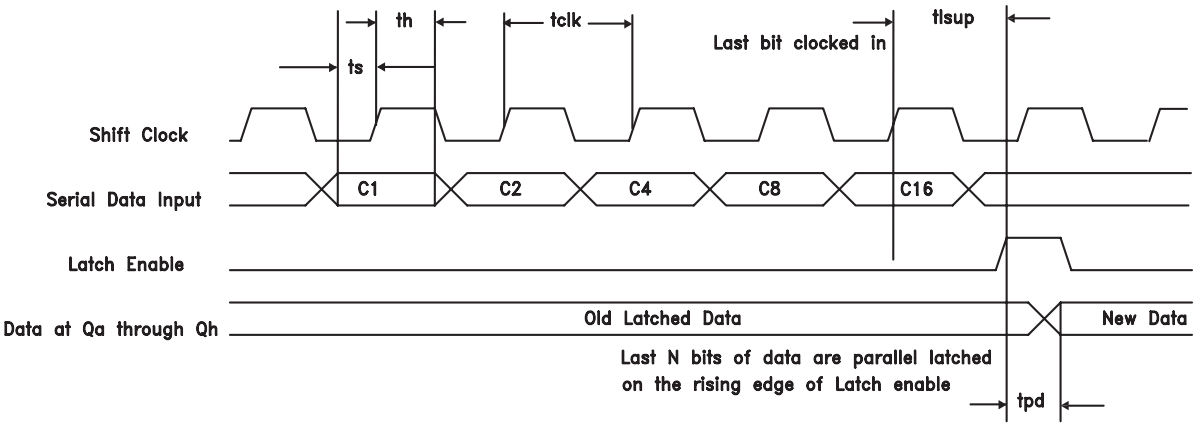
Truth Table

Serial Data Input					Attenuation Setting RF1 - RF2
C1	C2	C4	C8	C16	
High	High	High	High	High	Reference I.L.
Low	High	High	High	High	1 dB
High	Low	High	High	High	2 dB
High	High	Low	High	High	4 dB
High	High	High	Low	High	8 dB
High	High	High	High	Low	16 dB
Low	Low	Low	Low	Low	31 dB Max. Atten.

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Timing Diagram

Serial data is shifted in on the rising edge of the Shift clock, LSB first and is latched on the positive edge of Latch enable.



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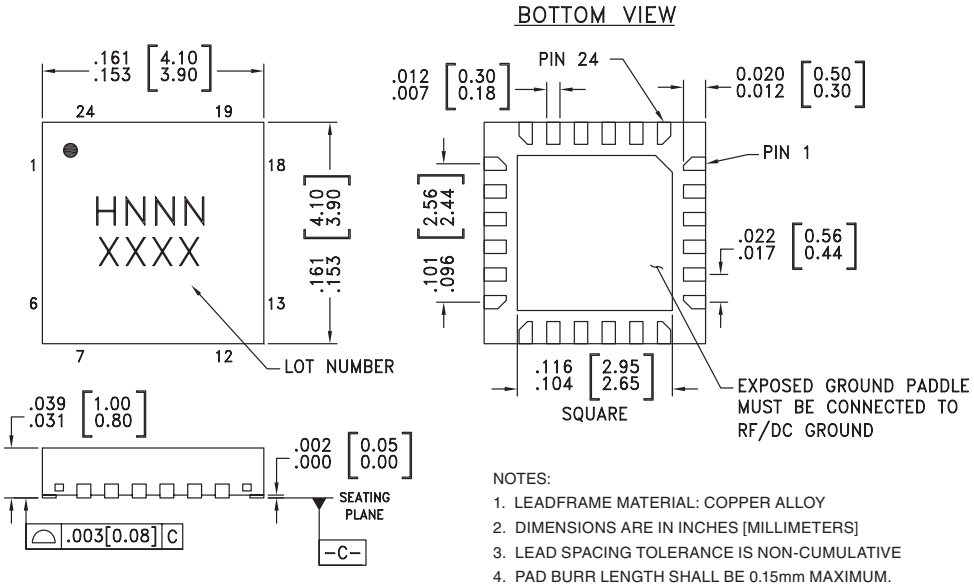
Absolute Maximum Ratings

Digital Inputs (Reset, Shift Clock, Latch Enable & Serial In)	-1.5 to (Vcc + 1.5) Vdc
Digital Outputs (Serial Out)	-0.5 to (Vcc+0.5)Vdc
DC Current on Serial Output	±35mA
Bias Voltage (Vcc)	+7.0 Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
RF Input Power (0.7 - 3.7 GHz)	+26 dBm
ESD Sensitivity (HBM)	Class 1A

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

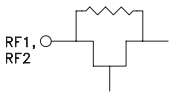
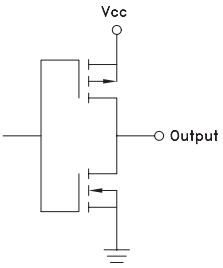
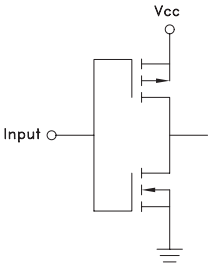
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

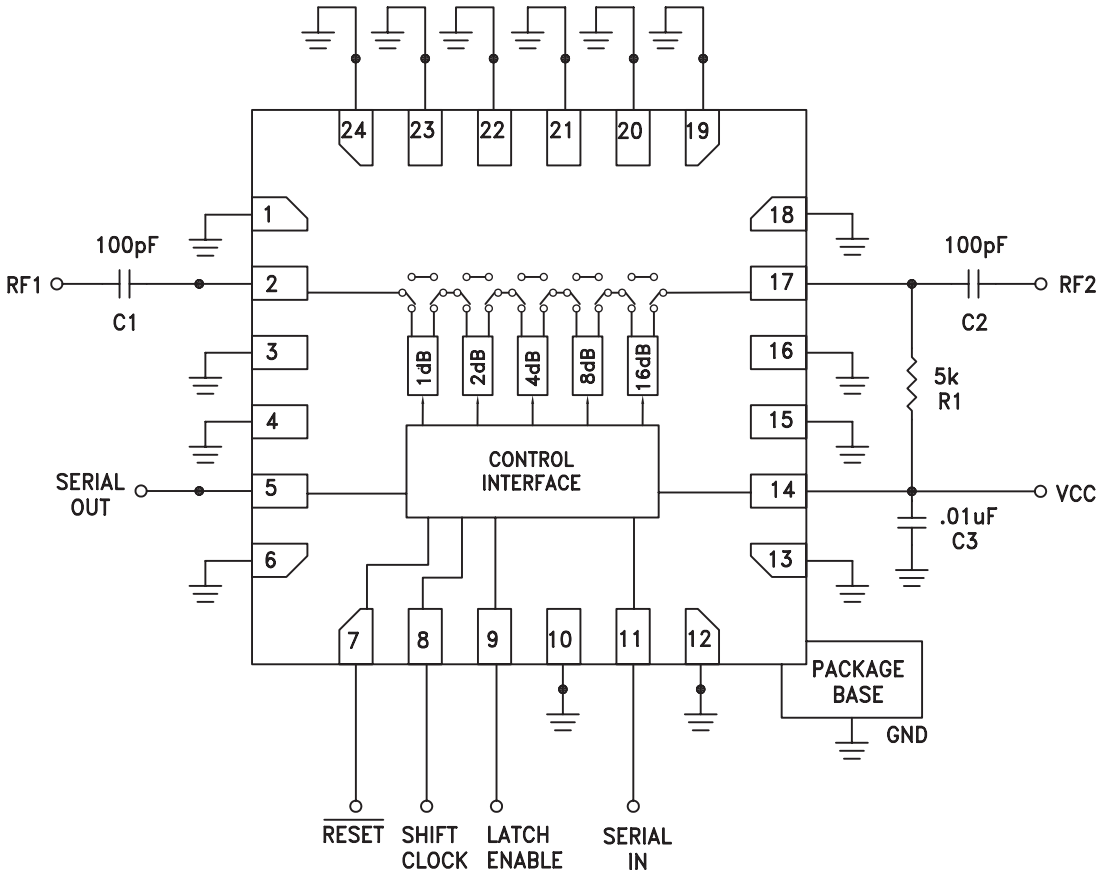
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC271LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H271 XXXX
HMC271LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H271 XXXX

[1] Max peak reflow temperature of 235 °C
[2] Max peak reflow temperature of 260 °C
[3] 4-Digit lot number XXXX

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 4, 6, 10, 12, 13, 15, 16, 18	N/C	These pins should be connected to PCB RF ground to maximize performance.	
2, 17	RF1, RF2	This pin is DC coupled and matched to 50 Ohms Blocking capacitors are required. Select value based on lowest frequency of operation.	
5	Serial Out	Serial data output. Serial input data delayed by 8 clock cycles.	
7	$\overline{\text{Reset}}$	See truth table, control voltage table and timing diagram.	
8	Shift clock		
9	Latch Enable		
11	Serial In		
14	Vcc	Supply Voltage.	
19 - 24	GND	Package bottom has an exposed metal paddle that must also be connected to RF/DC Ground.	

Application Circuit



DC blocking capacitors C1 & C2 are required on RF1 & RF2. Choose C1 = C2 = 100 ~ 300 pF to allow lowest customer specific frequency to pass with minimal loss. R1 = 5k Ohm is required to supply voltage to the circuit through either PIN 2 or PIN 17.

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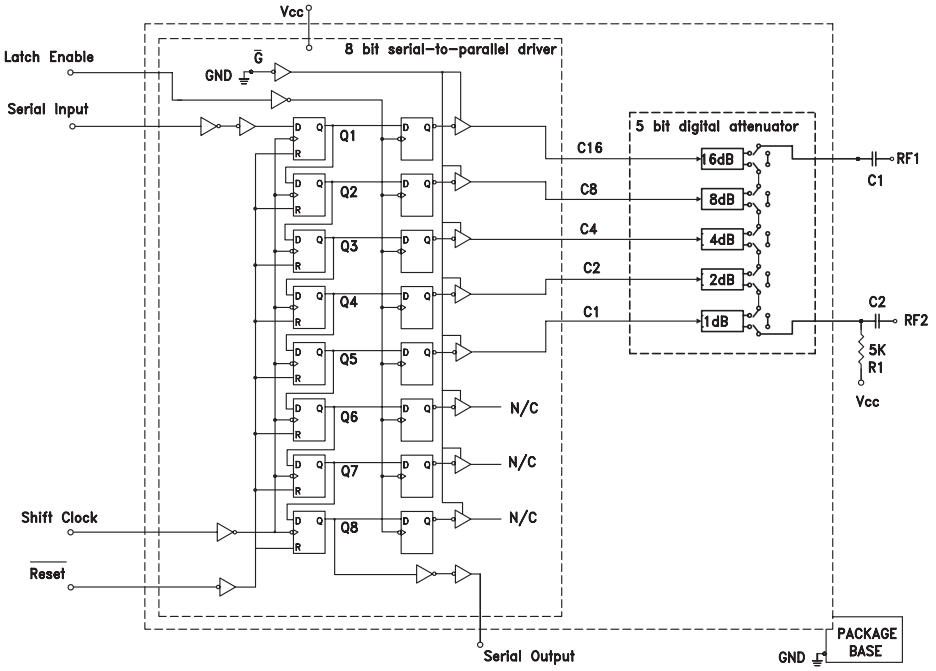
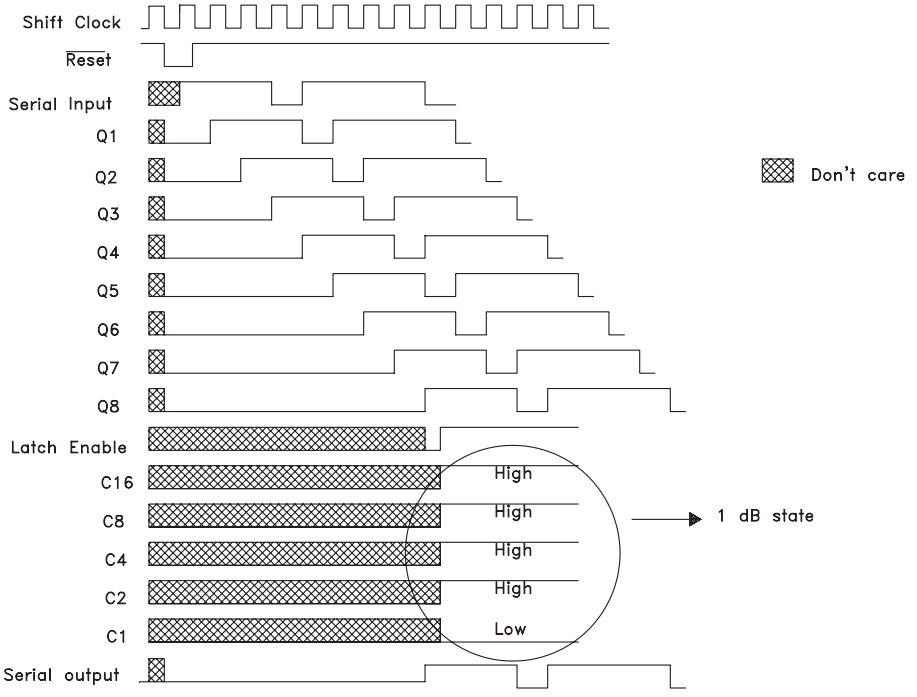
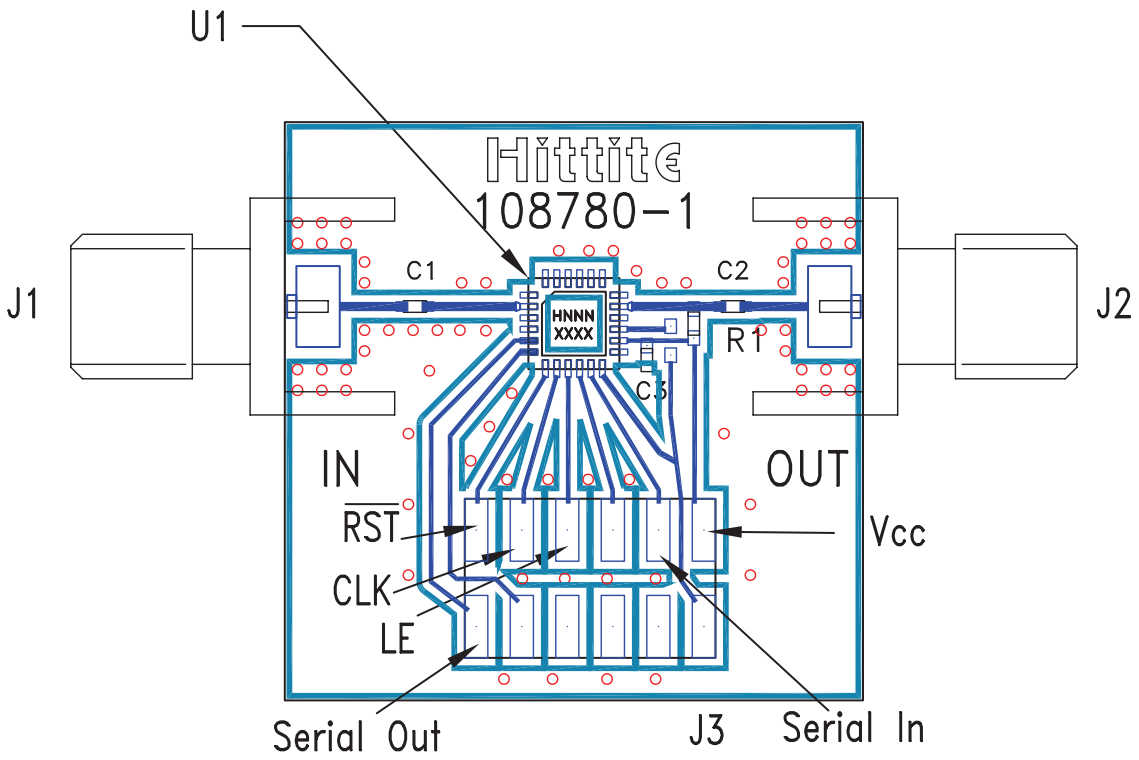
Logic / Functional Diagram



Programming Example to Select 1 dB State



Evaluation Circuit Board



List of Materials for Evaluation PCB 108782 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm Molex Header
C1, C2	100 pF Capacitor, 0402 Pkg.
C3	0.01 µF Capacitor, 0402 Pkg.
R1	5k Ohm Resistor, 0402 Pkg.
U1	HMC271LP4 / HMC271LP4E Digital Attenuator
PCB [2]	108780 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed ground paddle should be connected directly to the ground plane similar to that shown below. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board as shown is available from Hittite Microwave Corporation upon request.